

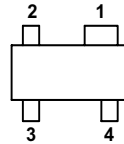
MOSMIC[®] for TV-Tuner Prestage with 5 V Supply Voltage

Comments

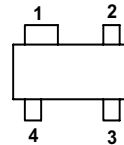
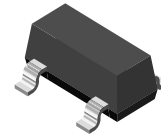
MOSMIC - MOS Monolithic Integrated Circuit

Features

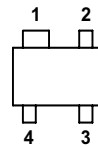
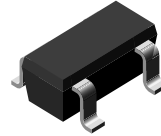
- Easy Gate 1 switch-off with PNP switching transistors inside PLL
- High AGC-range with less steep slope
- Integrated gate protection diodes
- Low noise figure
- High gain, very high forward transadmittance (40 mS typ.)
- Improved cross modulation at gain reduction
- SMD package
- Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC



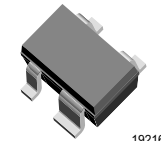
SOT-143



SOT-143R



SOT-343R



19216

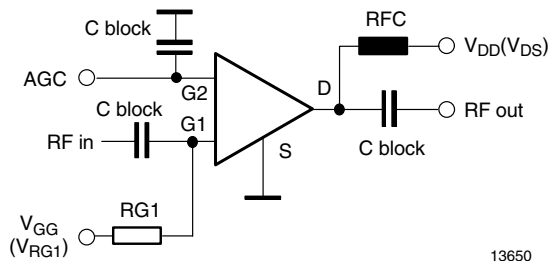


Electrostatic sensitive device.
Observe precautions for handling.

Applications

Low noise gain controlled input stages in UHF-and VHF- tuner with 5 V supply voltage.

Typical Application



13650

Mechanical Data

Typ: S503TX

Case: SOT-143 Plastic case

Weight: approx. 8.0 mg

Pinning: 1 = Source, 2 = Drain,
3 = Gate 2, 4 = Gate 1

Typ: S503TXR

Case: SOT-143R Plastic case

Weight: approx. 8.0 mg

Pinning: 1 = Source, 2 = Drain,
3 = Gate 2, 4 = Gate 1

Typ: S503TXRW

Case: SOT-343R Plastic case

Weight: approx. 6.0 mg

Pinning: 1 = Source, 2 = Drain,
3 = Gate 2, 4 = Gate 1

Parts Table

Part	Marking	Package
S503TX	X03	SOT-143
S503TXR	X8R	SOT-143R
S503TXRW	WX8	SOT-343R

Absolute Maximum Ratings

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Value	Unit
Drain - source voltage		V _{DS}	8	V
Drain current		I _D	30	mA
Gate 1/Gate 2 - source peak current		± I _{G1/G2SM}	10	mA
Gate 1 - source voltage		+ V _{G1S}	6	V
		- V _{G1S}	1.5	V
Gate 2 - source voltage		± V _{G2SM}	6	V
Total power dissipation	T _{amb} ≤ 60 °C	P _{tot}	200	mW
Channel temperature		T _{Ch}	150	°C
Storage temperature range		T _{stg}	- 55 to + 150	°C

Maximum Thermal Resistance

Parameter	Test condition	Symbol	Value	Unit
Channel ambient	1)	R _{thChA}	450	K/W

1) on glass fibre printed board (25 x 20 x 1.5) mm³ plated with 35 µm Cu

Electrical DC Characteristics

T_{amb} = 25 °C, unless otherwise specified

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Drain - source breakdown voltage	I _D = 10 µA, V _{G1S} = V _{G2S} = 0	V _{(BR)DSS}	12			V
Gate 1 - source breakdown voltage	± I _{G1S} = 10 mA, V _{G2S} = V _{DS} = 0	± V _{(BR)G1SS}	7		10	V
Gate 2 - source breakdown voltage	± I _{G2S} = 10 mA, V _{G1S} = V _{DS} = 0	± V _{(BR)G2SS}	7		10	V
Gate 1 - source leakage current	+ V _{G1S} = 5 V, V _{G2S} = V _{DS} = 0	+ I _{G1SS}			20	nA
Gate 2 - source leakage current	± V _{G2S} = 5 V, V _{G1S} = V _{DS} = 0	± I _{G2SS}			20	nA
Drain - source operating current	V _{DS} = V _{RG1} = 5 V, V _{G2S} = 4 V, R _{G1} = 56 kΩ	I _{DSO}	10	15	20	mA
Gate 1 - source cut-off voltage	V _{DS} = 5 V, V _{G2S} = 4, I _D = 20 µA	V _{G1S(OFF)}	0.3		1.3	V
Gate 2 - source cut-off voltage	V _{DS} = V _{RG1} = 5 V, R _{G1} = 56 kΩ, I _D = 20 µA	V _{G2S(OFF)}	0.8	1.0	1.4	V

Remark on improving intermodulation behavior:

By setting R_{G1} smaller than 56 kΩ, typical value of I_{DSO} will raise and improved intermodulation behavior will be performed.

Electrical AC Characteristics

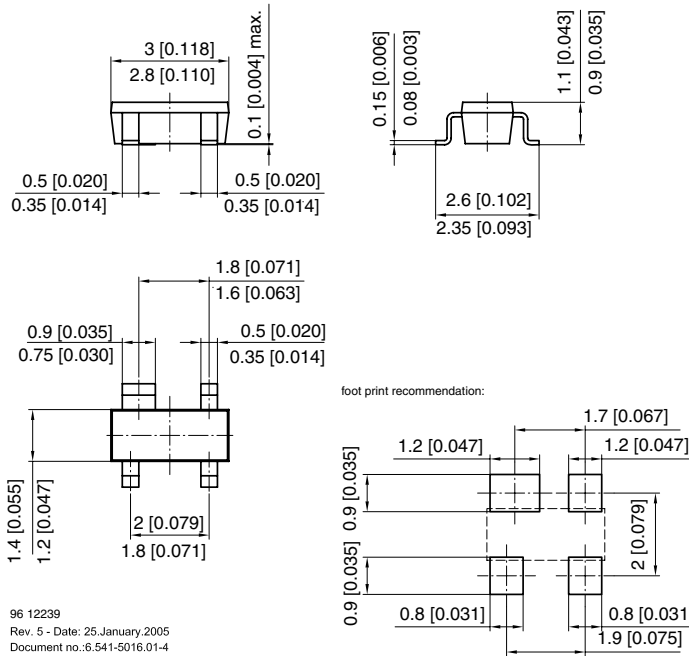
T_{amb} = 25 °C, unless otherwise specified

V_{DS} = 5 V, V_{G2S} = 4 V, I_D = 13 mA, f = 1 MHz

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Forward transadmittance		Y _{21s}	35	40	50	mS
Gate 1 input capacitance		C _{iSSg1}		2.3	2.8	pF
Feedback capacitance		C _{rSS}		30	40	fF
Output capacitance		C _{oss}		1.4		pF

Parameter	Test condition	Symbol	Min	Typ.	Max	Unit
Power gain	$G_S = 2 \text{ mS}$, $G_L = 0.5 \text{ mS}$, $f = 200 \text{ MHz}$	G_{ps}		30		dB
	$G_S = 3.3 \text{ mS}$, $G_L = 1 \text{ mS}$, $f = 800 \text{ MHz}$	G_{ps}	18	24		dB
AGC range	$V_{DS} = 5 \text{ V}$, $V_{G2S} = 1 \text{ to } 4 \text{ V}$, $f = 800 \text{ MHz}$	ΔG_{ps}	40	45		dB
Noise figure	$G_S = 2 \text{ mS}$, $G_L = 0.5 \text{ mS}$, $f = 200 \text{ MHz}$	F		1		dB
	$G_S = 3.3 \text{ mS}$, $G_L = 1 \text{ mS}$, $f = 800 \text{ MHz}$	F		1.3		dB
Cross modulation	Input level for $k = 1\% @ 0 \text{ dB}$ AGC $f_w = 50 \text{ MHz}$, $f_{unw} = 60 \text{ MHz}$	X_{mod}	90			dB μ V
	Input level for $k = 1\% @ 40 \text{ dB}$ AGC $f_w = 50 \text{ MHz}$, $f_{unw} = 60 \text{ MHz}$	X_{mod}	100	105		dB μ V

Package Dimensions in mm

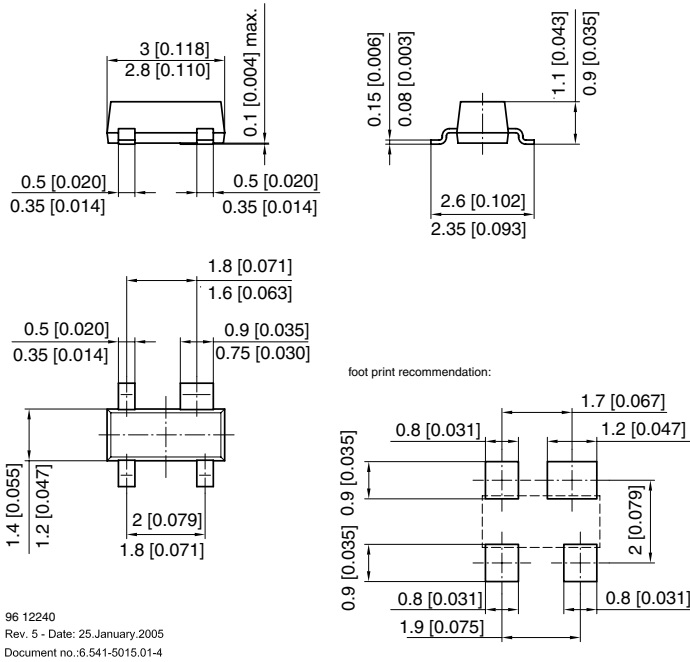


S503TX/S503TXR/S503TXRW

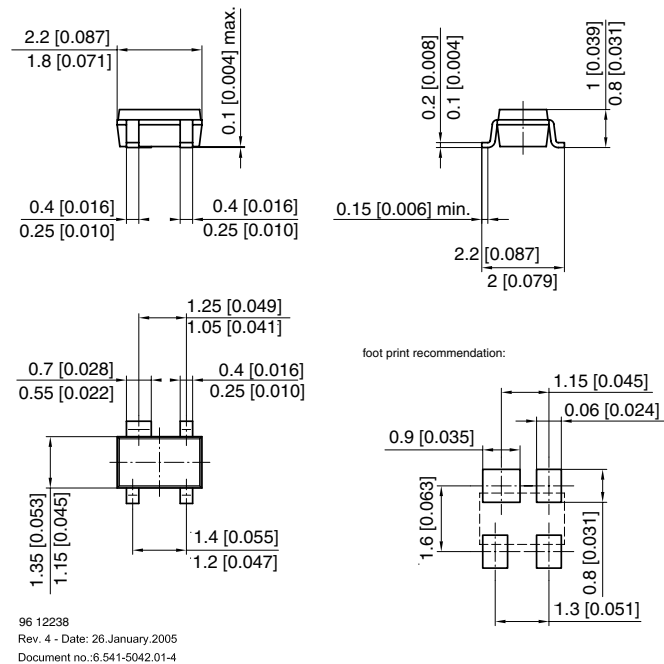


Vishay Semiconductors

Package Dimensions in mm



Package Dimensions in mm





Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

1. Meet all present and future national and international statutory requirements.
2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

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